

STB20NK50Z, STF20NK50Z STP20NK50Z, STW20NK50Z

N-channel 500 V, 0.23 Ω 17 A SuperMESH™ Power MOSFET Zener-protected TO-220, TO-247, TO-220FP, D²PAK

Features

Туре	V _{DSS}	R _{DS(on)} max	I _D	P _W
STB20NK50Z	500 V	< 0.27 Ω	17 A	190 W
STF20NK50Z	500 V	< 0.27 Ω	17 A	40 W
STP20NK50Z	500 V	< 0.27 Ω	17 A	190 W
STW20NK50Z	500 V	< 0.27 Ω	17 A	190 W

- Extremely high dv/dt capability
- 100% avalanche tested
- Gate charge minimized
- Very low intrinsic capacitances
- Very good manufacturing repeatability

Application

■ Switching applications

Description

The SuperMESH™ series is obtained through an extreme optimization of ST's well established strip-based PowerMESH™ layout. In addition to pushing on-resistance significantly down, special care is taken to ensure a very good dv/dt capability for the most demanding applications. Such series complements ST full range of high voltage MOSFETs including revolutionary MDmesh™ products.

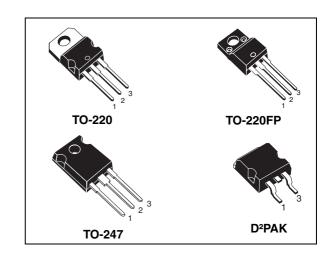


Figure 1. Internal schematic diagram

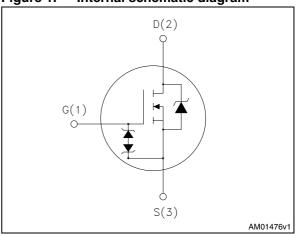


Table 1. Device summary

Order codes	Marking	Package	Packaging
STB20NK50Z	B20NK50Z	D ² PAK	Tape and reel
STF20NK50Z	F20NK50Z	TO-220FP	
STP20NK50Z	P20NK50Z	TO-220	Tube
STW20NK50Z	W20NK50Z	TO-247	

Contents STx20NK50Z

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STx20NK50Z Electrical ratings

1 Electrical ratings

Table 2. Absolute maximum ratings

		Value		
Symbol	Parameter	TO-220, TO-247, D ² PAK	TO-220FP	Unit
V _{DS}	Drain-source voltage (V _{GS} = 0)	500		V
V _{GS}	Gate-source voltage	± 30		V
I _D	Drain current (continuous) at T _C = 25 °C	17	17 ⁽¹⁾	Α
I _D	Drain current (continuous) at T _C = 100 °C 10.71 10.71		10.71	Α
I _{DM} ⁽²⁾	Drain current (pulsed)	68	68	Α
P _{TOT}	Total dissipation at T _C = 25 °C	190	40	W
	Derating factor	1.51		W/°C
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink $(t = 1 \text{ s; } T_C = 25 \text{ °C})$	2500		V
V _{ESD(G-S)}	Gate source ESD (HBM-C=100 pF, R=1.5 k Ω)	6000		
dv/dt (3)	Peak diode recovery voltage slope	4.5		V/ns
T _{stg}	Storage temperature	-55 to 150		°C
T _j	Max operating junction temperature	150		°C

^{1.} Limited only by maximum temperature allowed

Table 3. Thermal data

		,			
Symbol	Parameter	TO-220, D²PAK	TO-247	TO-220FP	Unit
R _{thj-case}	Thermal resistance junction-case max	0.66		3.1	°C/W
R _{thj-amb}	Thermal resistance junction-ambient max	62.5 50		62.5	°C/W
T _I	Maximum lead temperature for soldering purpose		300		°C

^{2.} Pulse width limited by safe operating area

 $^{3. \}quad I_{SD} \quad \leq 17 \, \text{ A, di/dt} \quad \leq \ 200 \, \text{ A/\mu s, } V_{DD} \quad \leq \ V_{(BR)DSS}, T_j \quad \leq T_{JMAX}.$

Electrical ratings STx20NK50Z

Table 4. Avalanche characteristics

Symbol Parameter		Value	Unit
I _{AR}	Avalanche current, repetitive or not-repetitive (pulse width limited by Tj Max)	17	Α
E _{AS}	Single pulse avalanche energy (starting $T_J=25$ °C, $I_D=I_{AR}$, $V_{DD}=50$ V)	850	mJ

2 Electrical characteristics

(T_{CASE} = 25 °C unless otherwise specified)

Table 5. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source breakdown voltage	I _D =1 mA, V _{GS} = 0	500			V
I _{DSS}	Zero gate voltage drain current (V _{GS} = 0)	V_{DS} = max rating V_{DS} = max rating, T_{C} = 125 °C			1 50	μ Α μ Α
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			± 10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	3.75	4.5	V
R _{DS(on)}	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 8.5 \text{ A}$		0.23	0.27	Ω

Table 6. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
9 _{fs} (1)	Forward transconductance	$V_{DS} = 15 \text{ V}, I_D = 8.5 \text{ A}$	-	13		S
C _{iss} C _{oss} C _{rss}	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$ $V_{GS} = 0$	-	2600 328 72		pF pF pF
Coss eq. (2)	Equivalent output capacitance	V _{DS} =0, V _{DS} = 0 to 640 V	-	187		pF
t _{d(on)} t _r t _{d(off)} t _f	Turn-on delay time Rise time Turn-off delay time Fall time	$V_{DD} = 250 \text{ V}, I_D = 8.5 \text{ A},$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see <i>Figure 19</i>)	-	28 20 70 15		ns ns ns ns
Q _g Q _{gs} Q _{gd}	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 400 \text{ V}, I_D = 17 \text{ A},$ $V_{GS} = 10 \text{ V}$ (see Figure 20)	-	85 15.5 42	119	nC nC nC

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

^{2.} $C_{oss\ eq.}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS} .

Electrical characteristics STx20NK50Z

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current Source-drain current (pulsed)		-		17 68	A A
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 17 \text{ A}, V_{GS} = 0$	-		1.6	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 17 A, di/dt = 100 A/µs V_{R} = 100 V (see <i>Figure 21</i>)	-	355 3.90 22		ns μC Α
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	I_{SD} = 17 A, di/dt = 100 A/µs V_{R} = 100 V, Tj = 150 °C (see <i>Figure 21</i>)	-	440 5.72 26		ns μC Α

^{1.} Pulsed: pulse duration=300µs, duty cycle 1.5%

Table 8. Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
BV _{GSO}	Gate-source breakdown voltage	Igs=± 1mA (open drain)	30			V

The built-in back-to-back Zener diodes have specifically been designed to enhance not only the device's ESD capability, but also to make them safely absorb possible voltage transients that may occasionally be applied from gate to source. In this respect the Zener voltage is appropriate to achieve an efficient and cost-effective intervention to protect the device's integrity. These integrated Zener diodes thus avoid the usage of external components.

^{2.} Pulse width limited by safe operating area

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220, Figure 3. Thermal impedance for TO-220, D²PAK

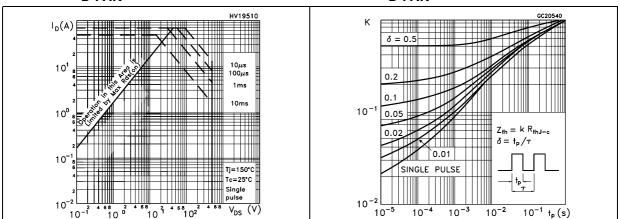


Figure 4. Safe operating area for TO-247

Figure 5. Thermal impedance for TO-247

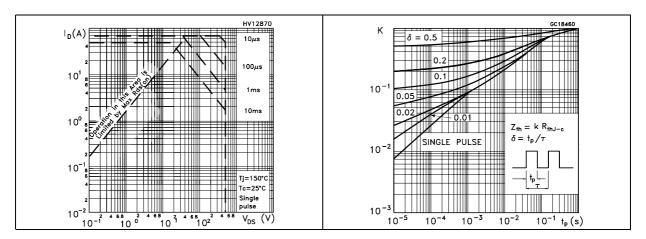
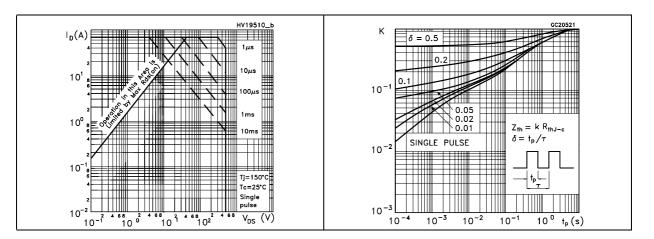


Figure 6. Safe operating area for TO-220FP Figure 7. Thermal impedance for TO-220FP



Electrical characteristics STx20NK50Z

Figure 8. Output characteristics

Figure 9. Transfer characteristics

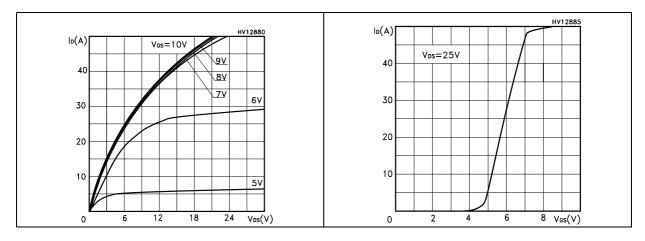


Figure 10. Transconductance

Figure 11. Static drain-source on resistance

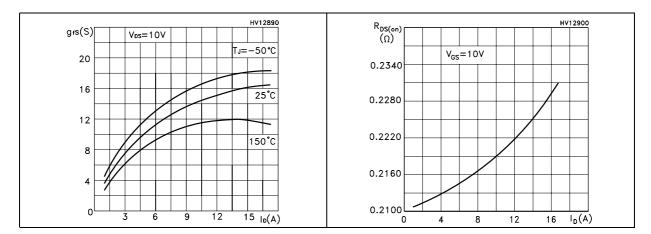


Figure 12. Gate charge vs gate-source voltage Figure 13. Capacitance variations

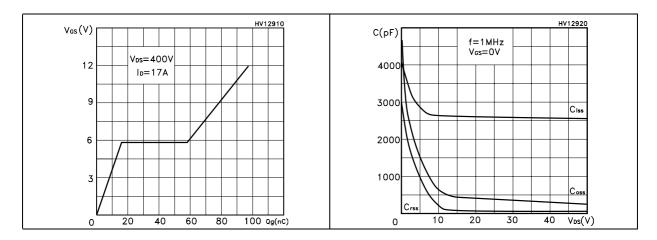


Figure 14. Normalized gate threshold voltage Figure 15. Normalized on resistance vs vs temperature temperature

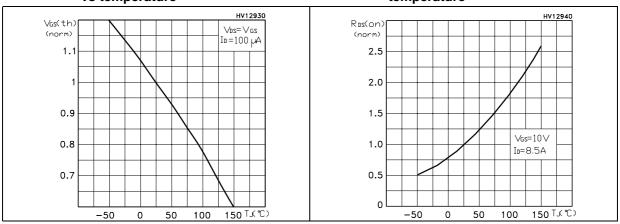


Figure 16. Maximum avalanche energy vs temperature

Figure 17. Normalized B_{VDSS} vs temperature

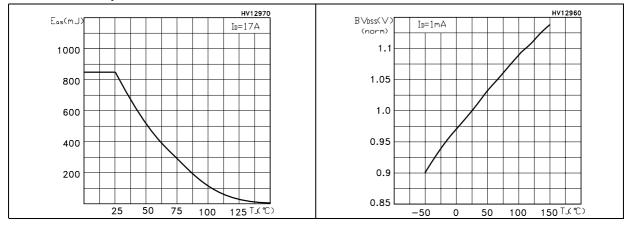
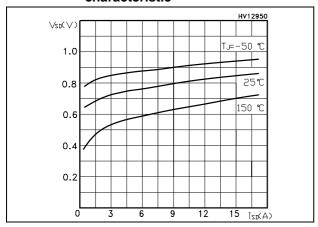


Figure 18. Source-drain diode forward characteristic



Test circuits STx20NK50Z

3 Test circuits

Figure 19. Switching times test circuit for resistive load

Figure 20. Gate charge test circuit

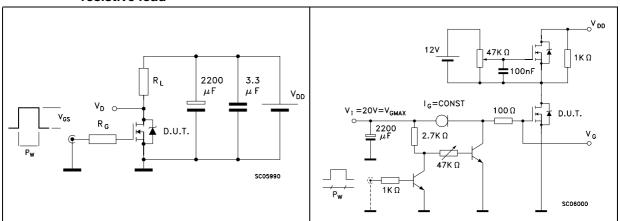


Figure 21. Test circuit for inductive load switching and diode recovery times

Figure 22. Unclamped inductive load test circuit

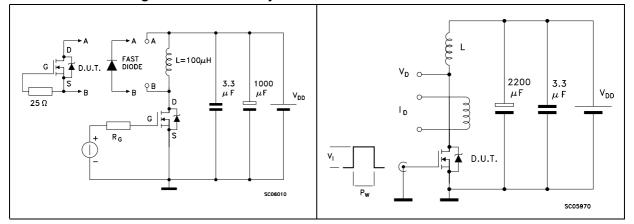
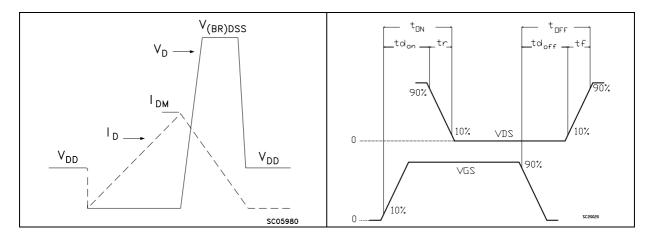


Figure 23. Unclamped inductive waveform

Figure 24. Switching time waveform



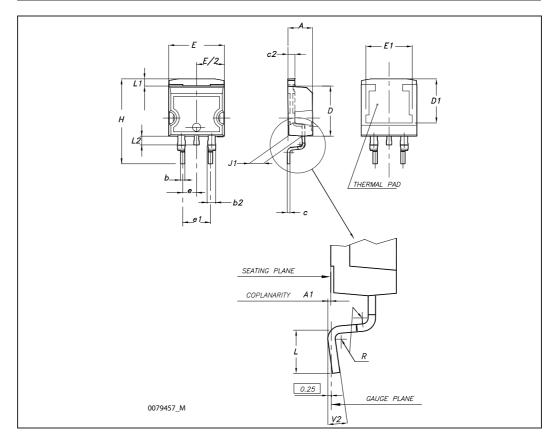
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4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

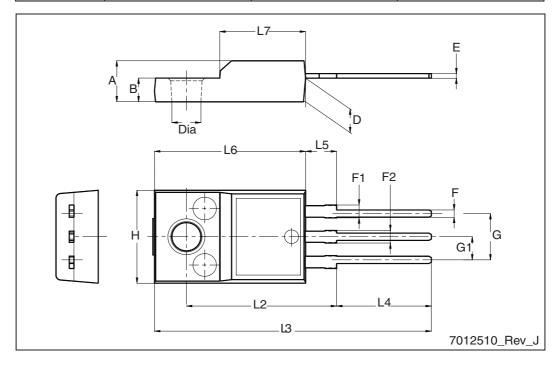
D²PAK (TO-263) mechanical data

Dim	Dim			inch		
Dilli	Min	Тур	Max	Min	Тур	Max
Α	4.40		4.60	0.173		0.181
A1	0.03		0.23	0.001		0.009
b	0.70		0.93	0.027		0.037
b2	1.14		1.70	0.045		0.067
С	0.45		0.60	0.017		0.024
c2	1.23		1.36	0.048		0.053
D	8.95		9.35	0.352		0.368
D1	7.50			0.295		
Е	10		10.40	0.394		0.409
E1	8.50			0.334		
е		2.54			0.1	
e1	4.88		5.28	0.192		0.208
Н	15		15.85	0.590		0.624
J1	2.49		2.69	0.099		0.106
L	2.29		2.79	0.090		0.110
L1	1.27		1.40	0.05		0.055
L2	1.30		1.75	0.051		0.069
R		0.4			0.016	
V2	0°		8°	0°		8°



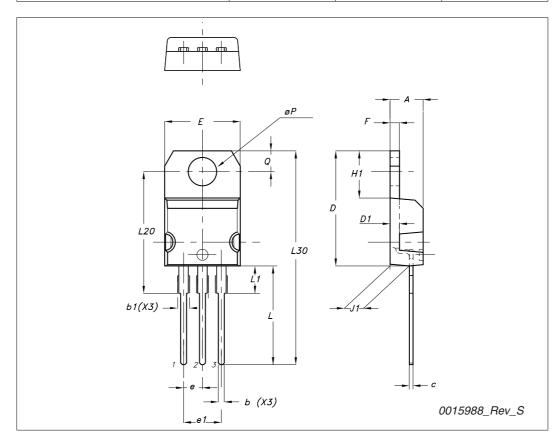
TO-220FP mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.4		4.6
В	2.5		2.7
D	2.5		2.75
E	0.45		0.7
F	0.75		1
F1	1.15		1.70
F2	1.15		1.5
G	4.95		5.2
G1	2.4		2.7
Н	10		10.4
L2		16	
L3	28.6		30.6
L4	9.8		10.6
L5	2.9		3.6
L6	15.9		16.4
L7	9		9.3
Dia	3		3.2

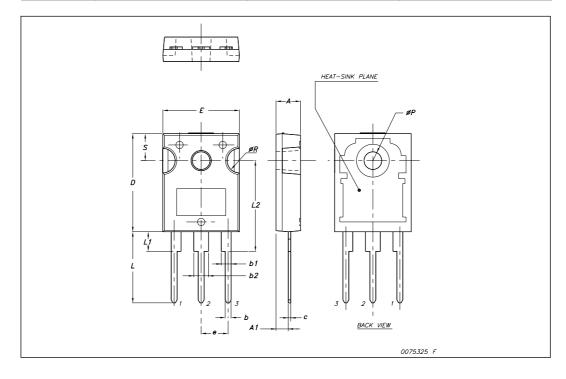


TO-220 type A mechanical data

Dim	mm		
Dim	Min	Тур	Max
A	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
E	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

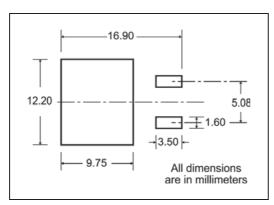


Dim.	mm.			
	Min.	Тур	Max.	
Α	4.85		5.15	
A1	2.20		2.60	
b	1.0		1.40	
b1	2.0		2.40	
b2	3.0		3.40	
С	0.40		0.80	
D	19.85		20.15	
Е	15.45		15.75	
е		5.45		
L	14.20		14.80	
L1	3.70		4.30	
L2		18.50		
øΡ	3.55		3.65	
øR	4.50		5.50	
S		5.50		

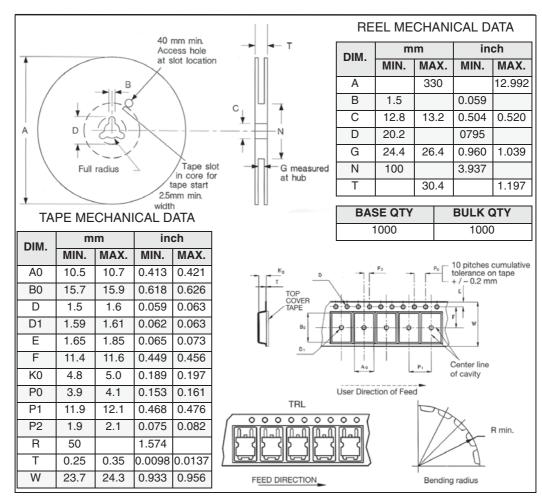


5 Packaging mechanical data

D²PAK FOOTPRINT



TAPE AND REEL SHIPMENT



STx20NK50Z Revision history

6 Revision history

Table 9. Document revision history

Date	Revision	Changes
21-Jun-2004	7	
26-Mar-2009	8	Added new package, mechanical data.
26-Nov-2009	9	Updated symbol for R _{DS(on)} in <i>Table 5: On/off states</i> .

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